

MICROCHIP PIC24 Dual Partition Flash Program Memory User Guide

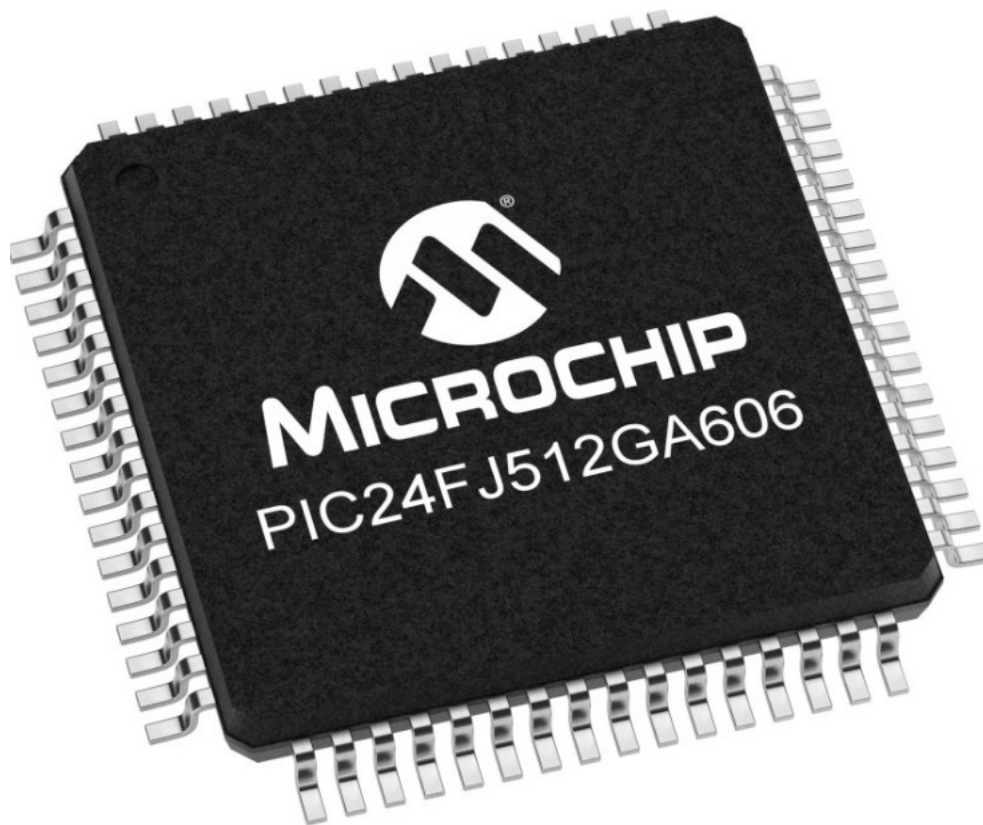
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MICROCHIP PIC24 Dual Partition Flash Program Memory



Product Information

All PIC24 and dsPIC33 devices come with an internal programmable Flash array that can be used to execute user code. The Flash array has a long retention life and a high number of read/write cycles, providing great flexibility in code development and storage. The dual partition Flash program memory has an updated version with new features.

- **Address space:** PIC24 and dsPIC33 devices address a 4M x 24-bit program memory address space.
- **User program space:** The program memory map is equally divided into the user program space (000000h to 7FFFFFFh).
- **Configuration memory space:** The program memory map is equally divided into the configuration (or test) memory space (800000h to FFFFFFFh).
- **Accessing program space:** There are three methods for accessing program space:
 1. The 23-bit Program Counter (PC).
 2. Table Read (TBLRD) and Table Write (TBLWT) instructions.
 3. By mapping any 32-Kbyte segment of program memory into the data memory address space.

INTRODUCTION

All PIC24 and dsPIC33 devices have an internal programmable Flash array for the execution of user code. The high-endurance Flash array provides great flexibility in code development and storage, combining a long retention life with a high number of read/write cycles.

This version of Flash program memory adds these new features:

- Dual Partition Flash operation, allowing the support of robust bootloader systems and fail-safe storage of application code, with options designed to enhance code security
- LiveUpdate operation, allowing the inactive Code Segment (CS) to be modified or completely erased while the

main application continues to execute

- Direct Run-Time Programming of the Flash array from the data RAM space, with optional compression of the data RAM image

Product Usage

To use the dual partition Flash program memory, follow these steps:

1. Consult the note at the beginning of the Dual Partition Flash Program Memory chapter in the current device data sheet to check whether this document supports the device you are using.
2. Download the device data sheets and family reference manual sections from the Microchip Worldwide Website at: <http://www.microchip.com>.
3. Access the program space using any of the three methods described above.
4. Implemented program memory can be further divided into the vector area, which includes the Reset and interrupt vectors, and the code area, which also includes the Flash configuration data. Accessing unimplemented areas of the user program space (i.e., above the upper implemented boundary of program memory) will cause an address error trap.

PROGRAM MEMORY ARCHITECTURE

PIC24 and dsPIC33 devices address a 4M x 24-bit program memory address space, as shown in Figure 2-1. The program memory map is equally divided into the user program space (000000h to 7FFFFFFh) and the configuration (or test) memory space (800000h to FFFFFFFh). The user program space contains the Reset vector, Interrupt Vector Tables (IVTs) and program memory. There are three methods for accessing program space.

1. The 23-bit Program Counter (PC).
2. Table Read (TBLRD) and Table Write (TBLWT) instructions.
3. By mapping any 32-Kbyte segment of program memory into the data memory address space.

Implemented program memory can be further divided into the vector area, which includes the Reset and interrupt vectors, and the code area, which also includes the Flash configuration data. Accessing unimplemented areas of the user program space (i.e., above the upper implemented boundary of program memory) will cause an address error trap.

Vector Area

The vector area starts at the beginning of program memory space, at 000000h. It contains the Master Reset vector, the hardware trap vectors and the Interrupt Vector Table (IVT) for all implemented hardware interrupts. Because of architectural differences and the size of the IVT, the vector area occupies a different amount of memory in different device families. For PIC24 devices, the vector area extends to 0000FEh. For dsPIC33 devices, the vector area extends to 0001FEh. Figure 2-2 shows the difference between the IVTs for different devices. Regardless of device family, hardware interrupt vectors always start at 000014h with Interrupt Vector 0. The vector area roughly corresponds to the Vector Segment (VS) in CodeGuard™ security implementations. Depending on the security configuration, the vector area may be treated as part of the Boot Segment (BS) or the General Segment (GS).

ALTERNATE VECTOR INTERRUPT TABLE

All dsPIC33 and PIC24 devices provide for the implementation of an Alternate IVT (AIVT), which can be used in high-security code applications and for alternate exception handling. Unlike earlier devices in these families, the AIVT is not permanently allocated in program memory at a fixed address range. Instead, AIVT is only present when:

- CodeGuard security is configured for a Boot Segment with a size of at least two pages (set by the FBSLIM Configuration register), and
- AIVT is enabled by programming the AIVTDIS Configuration bit to '0'.

When the AIVT is enabled, it is located at an address range starting at the beginning of the last page of the BS; each vector is located at a fixed offset from the page boundary. The total size and content (i.e., vector order) of the AIVT mirrors those of the IVT.

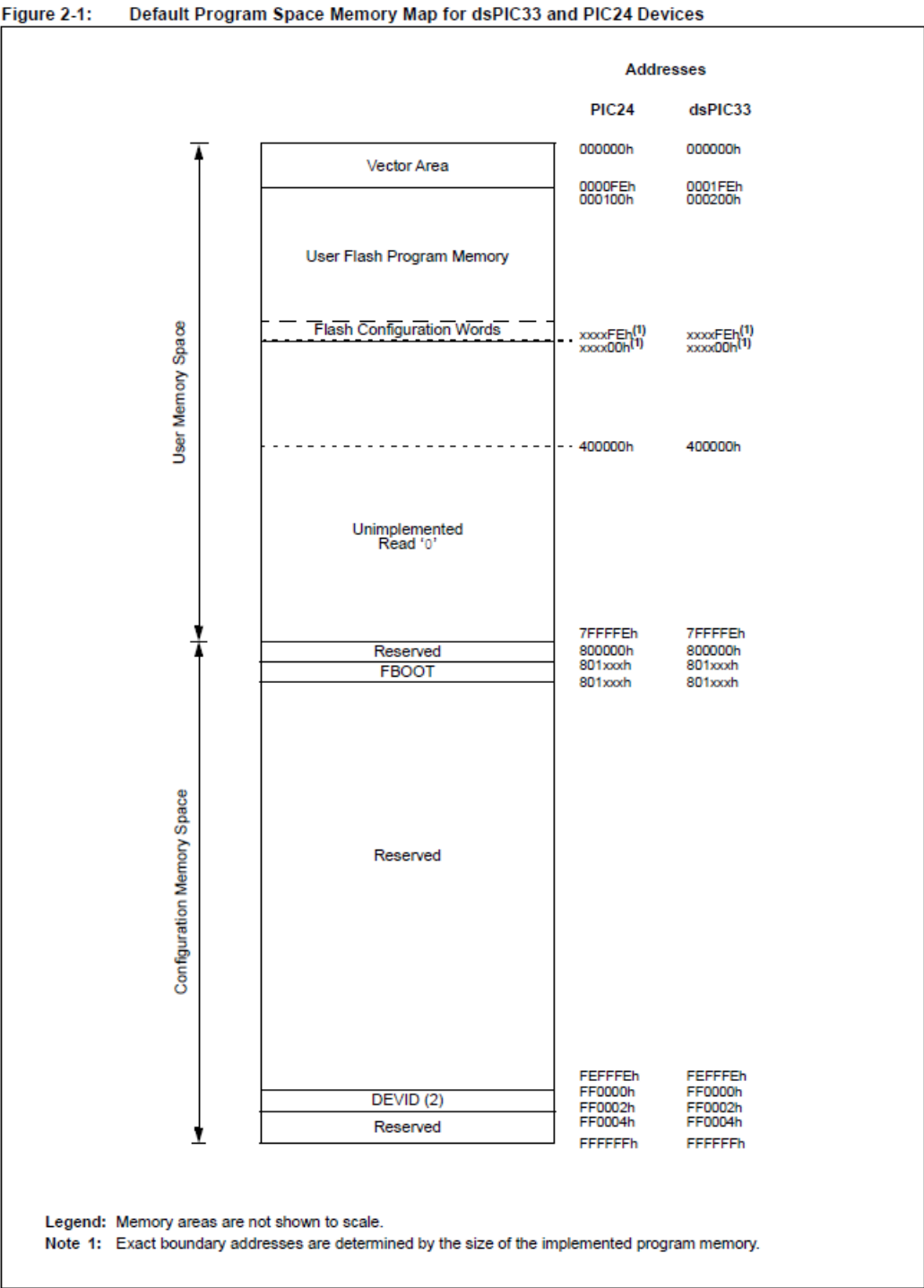
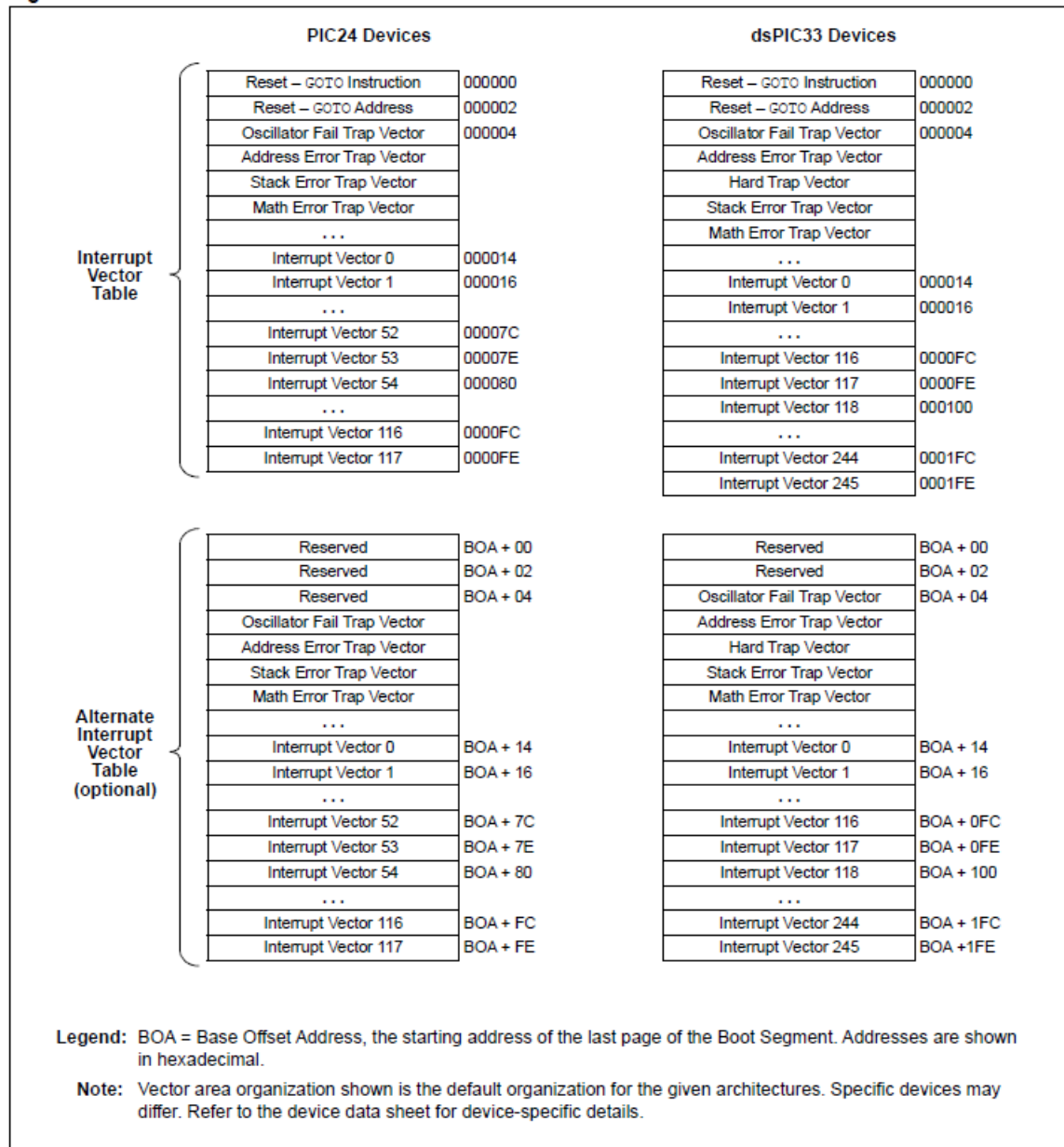


Figure 2-2: Vector Area Detail



Code Area

The code area is the area of user program memory that contains the user's application code. It extends from the end of the vector area to the beginning of the Flash Configuration Words. If a Boot Segment is implemented, it starts at the end of the vector area and extends for a predetermined range. The part of the code area that is not in the Boot Segment corresponds to the General Segment (GS) in CodeGuard security systems. Except the Flash Configuration Words at the end of implemented memory, as described below, the entire area is available for application code.

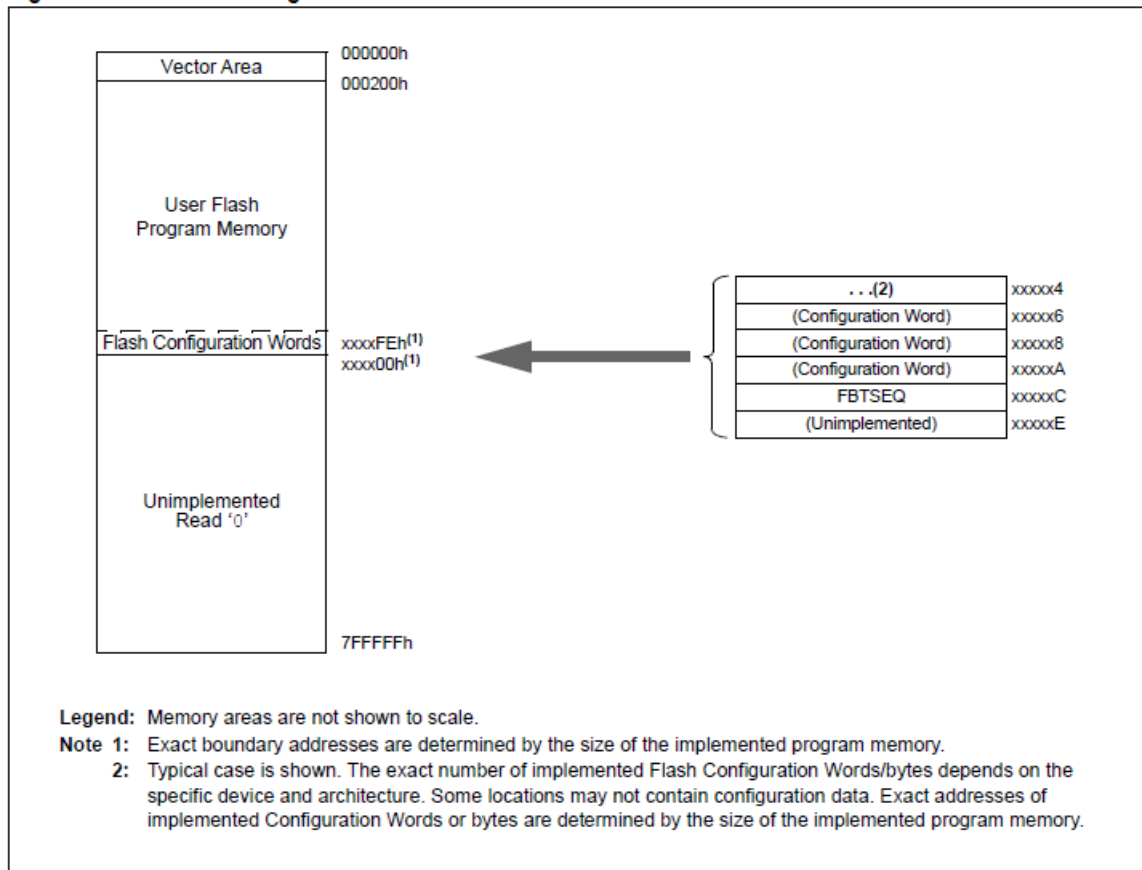
FLASH CONFIGURATION DATA

The area at the end of implemented Flash program memory (typically the last row) is reserved for Flash configuration data. On device Reset, this configuration information is copied into the appropriate device Configuration registers, which are not accessible to the user. Device configuration data can only be programmed by programming the desired values in the Flash Configuration Words.

The number, order and organization of the Configuration bits vary between device architectures, and among device families within the same architecture. Some devices organize Configuration bits as 16-bit Configuration Words, which are generally grouped in functional terms. Other devices organize Configuration bits in terms of individually addressable Configuration bytes. Figure 2-3 shows the area as organized for Configuration Words. Refer to the device data sheet for family-specific information.

For devices with Dual Partition capability, the FBTSEQ Configuration Word is usually the next-to-last Configuration Word, located at the end of implemented program memory.

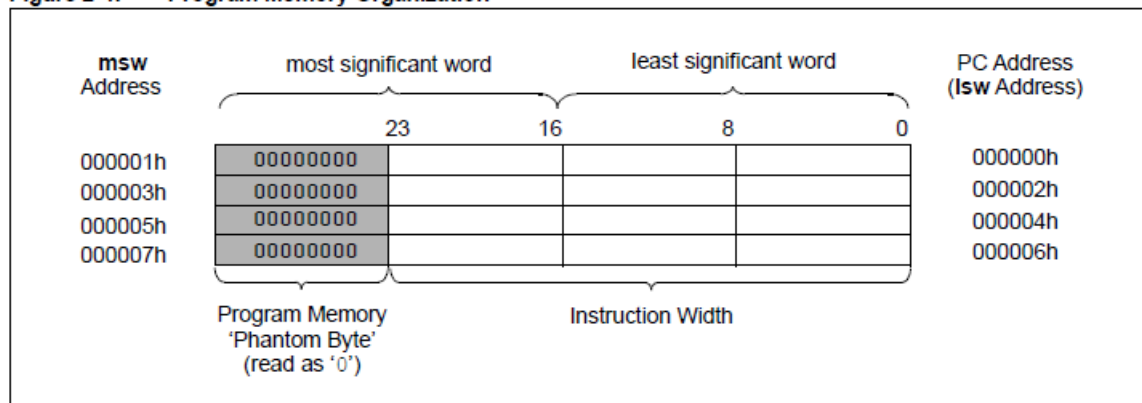
Figure 2-3: Flash Configuration Words



Memory Organization

The program memory space is organized as word-addressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address (Figure 2-4). Program memory addresses and the PC are always word-aligned on the lower word (i.e., the Least Significant bit (LSb) is always '0'). Addresses are incremented or decremented by two during code execution.

Figure 2-4: Program Memory Organization



ADDRESSING PROGRAM MEMORY

For normal code execution, the Effective Address (EA) for execution is provided by the Program Counter (PC). The PC is 23 bits wide, allowing direct access to any location in the user program space. PC[0] is fixed as '0' in order to maintain program instruction alignment. The PC is incremented to the next sequential address by incrementing PC[1], thus increasing the value of the PC by two.

For Table Read and Table Write operations, the EA is created by concatenating the 16-bit address from one of the W registers with the 8-bit address from the TBLPAG register. This permits table operations access to both the user and configuration spaces. Address generation for table operations is discussed in more detail in Section 4.2.1 "Address Generation for Table Operations".

For Extended Data Space (EDS) and Program Space Visibility (PSV) operations, the EA is created by concatenating the lower 15 bits of a W register with the 8-bit address from either the DSRPAG/DSWPAG

(dsPIC33) or PSVPAG (PIC24F) registers. Extended Data Space and Program Space Visibility operations are discussed in the “dsPIC33/PIC24 Family Reference Manual”, “Data Memory” (dsPIC33, DS70595) and/or “Data Memory” (PIC24, DS30009717).

PROGRAM MEMORY PARTITION FLASH OPERATION

For devices with Dual Partition Flash capability, the Dual Partition Program Memory mode is selected by programming the BTMODE[1:0] bits in the FBOOT Configuration Word. Unlike other Configuration Words, FBOOT is located in configuration memory space, apart from all other Flash Configuration registers. The exact address is architecture-specific (i.e., PIC24 or dsPIC33) and may vary between device families. Table 3-1 lists the possible Flash Partition options, which are discussed in the following sections.

When a device is first programmed via In-Circuit Serial Programming™ (ICSP™), the programmer should program FBOOT to correctly set the device Flash Partition mode. Note that it is not possible to reprogram FBOOT at run time using Run-Time Self-Programming (RTSP). The FBOOT bits must be configured in ICSP mode by a programmer. This is because the location of the Flash Configuration Words changes from Standard Partition mode to Dual Partition mode, which could cause unexpected device operation.

Table 3-1: Flash Partition Options

BTMODE[1:0]	Partition Option
11	Standard Mode (Single Partition, default)
10	Dual Partition Mode
01	Protected Dual Partition Mode
00	Privileged Dual Partition Mode(1)

Note 1: Not implemented on all Dual Partition devices.

Standard (Single Partition) Mode

Standard mode, also referred to as Single Partition or Standard Partition mode, is the default operating mode for program memory. It is selected when the BTMODE_x Configuration bits are ‘11’ (their unprogrammed configuration). This is also the single program memory operating mode available to all previous dsPIC33 and PIC24 devices. In Standard mode, the entire user program memory is mapped as a flat, continuous memory space, ranging from 000000h to the upper boundary of implemented Flash memory. For example, a device with 256 Kbytes of Flash memory has a program memory address range of 000000h to 02AFFh, with addresses above this range being unimplemented. The entire implemented memory range (excluding reserved spaces for Reset vectors, IVTs and Flash Configuration Words) is available for the user’s application. In devices with segmented code security, a Boot Segment may also be implemented.

Dual Partition Modes

When the BTMODE_x Configuration bits are programmed to a value other than ‘11’, the device operates in one of three Dual Partition modes. In all of these modes, the implemented Flash memory is symmetrically split into two regions: an Active Partition, beginning at 000000h, and an Inactive Partition, beginning at 400000h. For the device in the previous example, the 256-Kbyte Flash memory would be implemented as two areas of 128 Kbytes each, ranging from addresses 000000h to 0157FFh and 400000h to 4157FFh. Addresses between the two areas are unimplemented (see Figure 3-1).

In the Dual Partition modes, two independent applications may be programmed into the device, one to each of two Flash memory partitions, known as Partition 1 and Partition 2. When the device is initialized, one of these is dynamically mapped to the Active Partition and executed. The other is mapped to the Inactive Partition, where it remains available to program memory operations. The assignment of a partition to the Active or Inactive Partition is determined automatically by a code signature, known as the Boot Sequence Number. The code partitions may also be swapped between Active and Inactive Partitions, during run time, under software control.

Dual Partition modes allow for the Active Partition's application to access (but not execute) program data in the Inactive Partition or to reprogram the Inactive Partition. Writing to Flash memory in the Inactive Partition does not require the CPU to stall while Flash writes occur. This allows for LiveUpdate functionality, where execution of critical control functions or timing-sensitive communications can happen simultaneously with application updates. Certain Dual Partition modes place additional limitations on the process to help ensure code security and robustness of operation. Code cannot be executed when it is mapped to the Inactive Partition. The partitions may be swapped, but only code in the Active Partition can be executed.

1. DUAL PARTITION MODE

The simplest Dual Partition mode places no restrictions on operations from the Active Partition to the code in either Partitions 1 or 2. Any limitations on the interactions between Code Segments in different partitions are determined by the configuration of enhanced security features.

2. PROTECTED DUAL PARTITION MODE

Protected Dual Partition mode protects the default Code Segment (Partition 1) from any Flash write or erase operations. This allows for the implementation of a "Factory Default" mode by allowing a fail-safe backup image to be stored in Partition 1. When Protected Dual Partition mode is used, Partition 1 cannot be written or erased by Flash memory operations while it is in the Inactive Partition. If Partition 1 is also write-protected via Configuration bit settings, it cannot be erased or written at any time. In contrast, Partition 2 can be erased or written by operations from either partition. This allows for a fail-safe bootloader to be placed in Partition 1, along with a fail-safe backup code image. This code image can then be executed by default and used to rewrite Partition 2 in the event that a Flash update should fail.

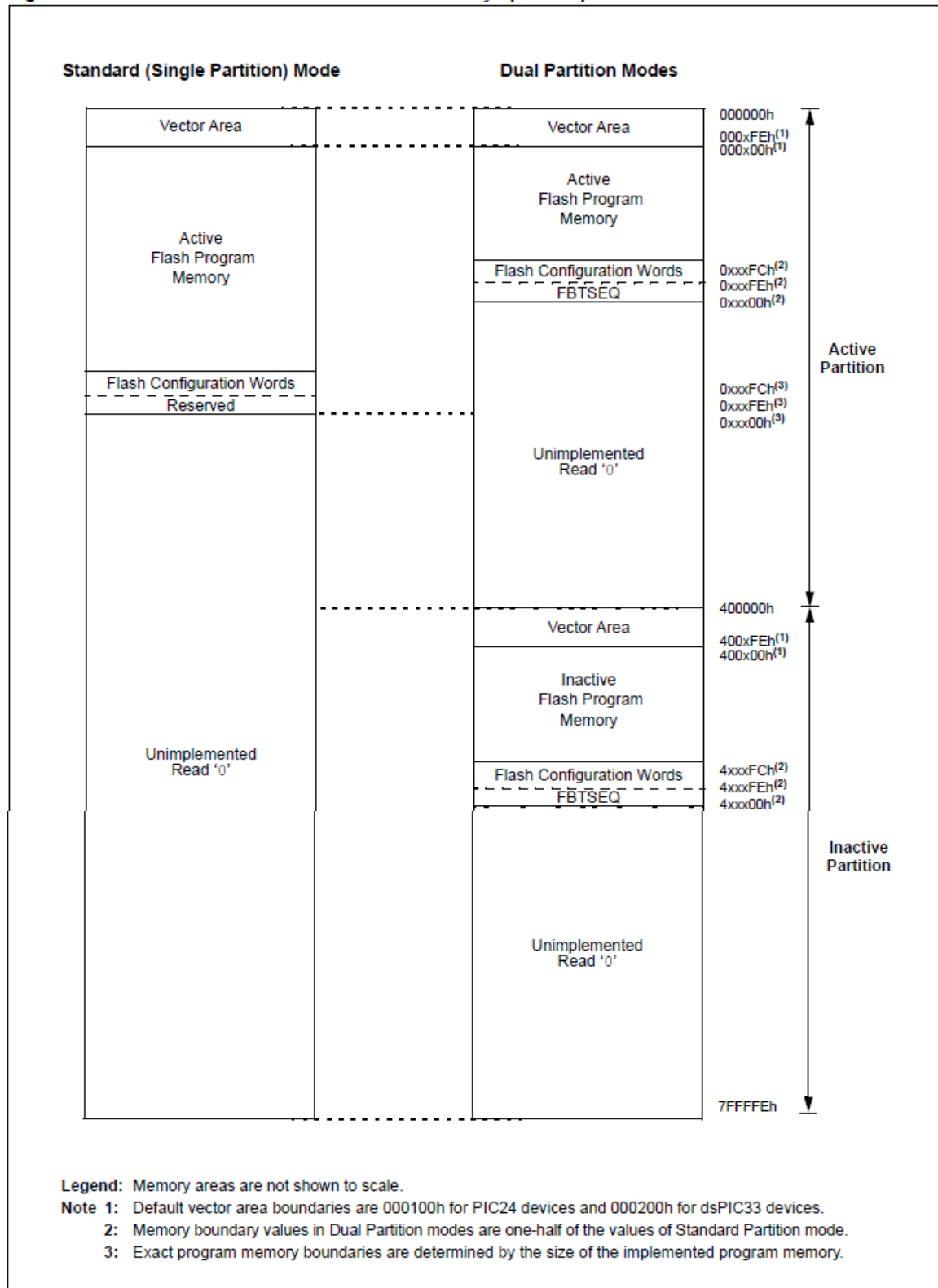
3. PRIVILEGED DUAL PARTITION MODE

Privileged Dual Partition mode implements additional security protections in those cases where an application may have Code Segments written by different authors and a higher level of security is required to protect intellectual property for one of those segments. An example would be a system where the bulk of the code is written by the hardware's application developer, but includes a proprietary, third-party library. This mode is designed to work with the enhanced security features in select devices, which can selectively protect different Code Segments in the program memory space.

Privileged Dual Partition mode differs from Standard Dual Partition mode by adding special protection to the BSLIMx Configuration bits of both partitions. This protection effectively locks the bits, and prevents changes to the size of the Boot Segment and the General Segment. With the proper security settings, this ensures that neither segment will be altered or unexpectedly read at run time.

Privileged Dual Partition mode is not implemented on all devices with Dual Partition capability. Refer to the specific device data sheet for details.

Figure 3-1: Standard and Dual Partition User Memory Space Map



4. SELECTING A CODE PARTITION

In Dual Partition modes, there are two methods of determining which partition will be mapped to the Active Partition and executed: the Boot Sequence Number and the BOOTSWP instruction. The P2ACTIV bit (NVMCON[10]) can be used to determine which physical partition is the Active Partition. If P2ACTIV = 1, Partition 2 is active; if P2ACTIV = 0, Partition 1 is active. The Boot Sequence Number is a 12-bit value that is used for automatically determining the Active Partition upon device Reset. Each partition should have a unique Boot Sequence Number, which is stored in the FBTSEQ Flash Configuration Word. The BOOTSWP instruction is used to swap Active and Inactive Partitions without a device Reset.

1. Boot Sequence Number

The 12-bit Boot Sequence Number is stored in the FBTSEQ Flash Configuration Word, which is always

located at the last location of user program memory, above the other Flash Configuration Words (see Figure 3-2). Unlike other Configuration registers, which only use the lower 16 bits of the program memory word, FBTSEQ is a full 24 bits wide. Each partition should, under normal operating conditions, have a different value for FBTSEQ. When Dual Partition modes are not used, the value of FBTSEQ is ignored. The Boot Sequence Number is stored in two parts: the actual value in the bit field, BSEQx (FBTSEQ[11:0]), and the one's complement of the value in the IBSEQx bits field (FBTSEQ[23:12]). When the Boot Sequence Number is read upon a device Reset, the values of BSEQx and IBSEQx are automatically compared. If these two values are not mutual complements, the Boot Sequence Number is considered invalid. The complement value is not automatically created by hardware, nor is it verified by hardware upon programming. The application must calculate and program the appropriate value.

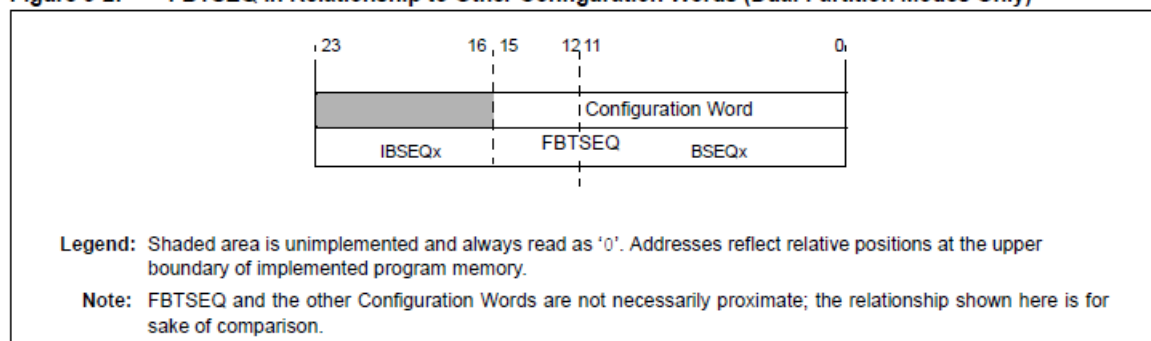
On device Reset, the Boot Sequence Numbers in both partitions are compared. The partition with the lower BSEQx value is the one that is mapped to the Active Partition and its code is executed. If one of the Boot Sequence Numbers is invalid, the device will select the partition with the valid Boot Sequence Number as the Active Partition, regardless of which Boot Sequence Number is lower. If both Boot Sequence Numbers are invalid, Partition 1 will be selected by default as the Active Partition.

The partitions can be prepared to be swapped during run time by reprogramming the Boot Sequence Number of the Inactive Partition to have a lower value. When a Reset is executed, the partition that has the lower value now becomes active. This method is used when the Inactive Partition has been updated and is then mapped to the Active Partition after a Reset.

The location of FBTSEQ allows it to be easily excluded from a checksum or other verification of the Flash program memory. Because the FBTSEQ value is likely to be determined at run time (based on the BSEQx of the other partition), it often cannot be included in a checksum, such as a CRC.

The sequence at the top of Figure 3-3 shows the relationship between the code partitions when the Boot Sequence Number is altered and a device Reset is executed.

Figure 3-2: FBTSEQ in Relationship to Other Configuration Words (Dual Partition Modes Only)



2. BOOTSWP Instruction

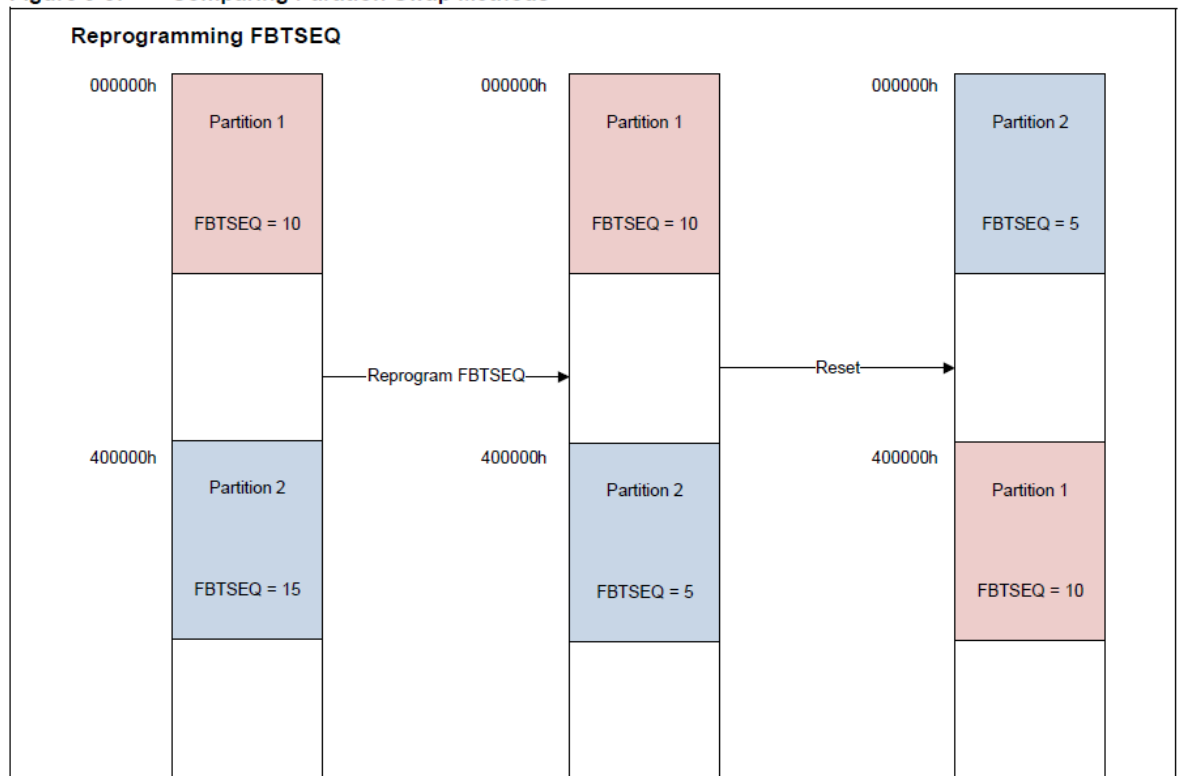
The BOOTSWP instruction is an extension to the PIC24 and dsPIC33 instruction set. It supports the code, LiveUpdate, by allowing Code Segments to be swapped between the Active and Inactive Partitions without the need for a device Reset. A partition swap using the BOOTSWP instruction is referred to as a “soft swap”. To execute a BOOTSWP instruction, the Configuration bit, BTSPW (FIDC[25]), must be cleared. If a BOOTSWP instruction is attempted with BTSPW set, a NOP instruction will result.

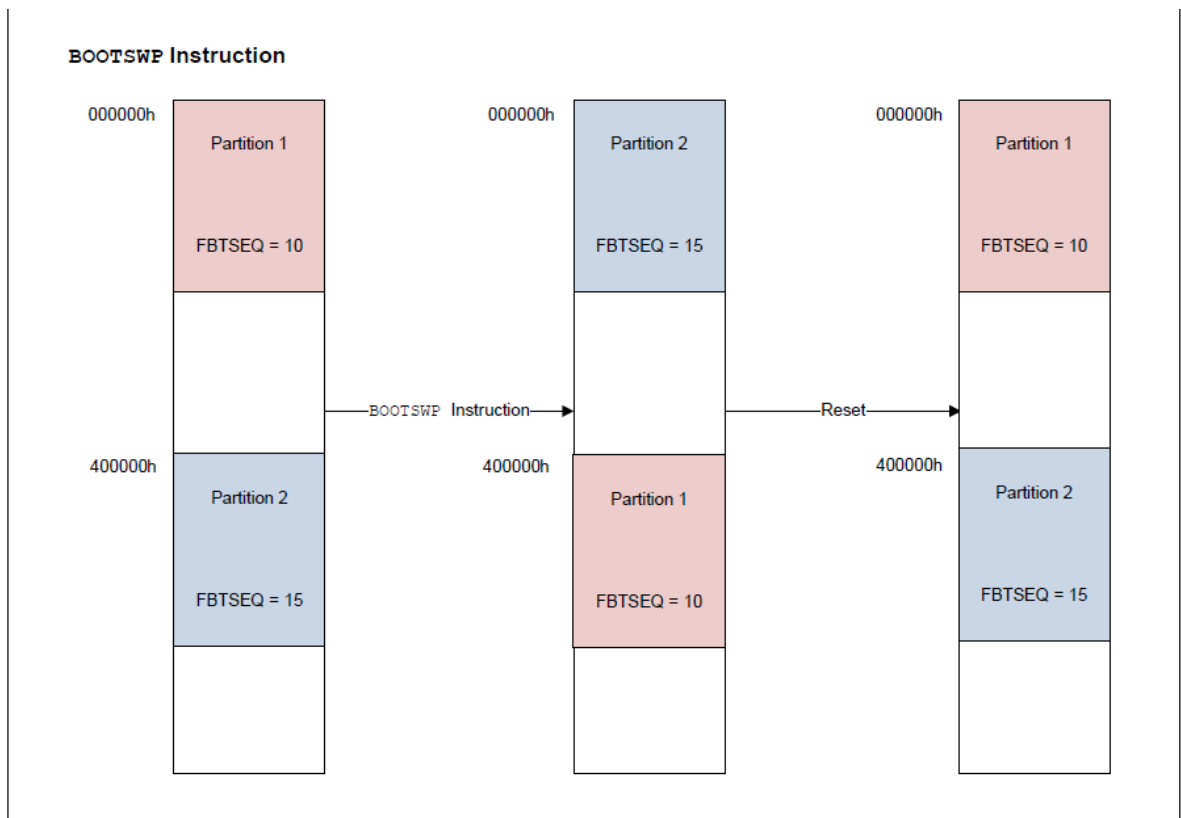
The BOOTSWP instruction must always be followed by a single-word instruction that writes the PC (e.g., GOTO W, CALL W or BRA W); the target of the instruction must be at an address within 32 Kbytes of the current address. Upon execution, the Active and Inactive Partitions trade places, and the PC vectors to the location specified by the GOTO instruction in the newly Active Partition.

Note: If the BOOTSWP instruction is executed from within a function that has created a new stack frame using the LNK instruction, a CALL must be used following BOOTSWP rather than a GOTO; otherwise, the device will generate a stack error trap.

- After the execution of the BOOTSWP instruction, the SFTSWP bit (NVMCON[11]) is set. This bit indicates to the firmware that the BOOTSWP instruction occurred correctly and that the currently Active Partition was entered via BOOTSWP rather than via a device Reset. Status bit, P2ACTIV (NVMCON[10]), can also be read to verify which partition is active.
- It is important to note that, after the partition swap, all peripherals and interrupts which were previously enabled remain enabled. Additionally, the RAM and stack maintain their states after the swap. It is highly recommended that applications using soft swaps jump to a routine that re-initializes the device in order to ensure the application continues to run as expected.
- For robustness of operation, it is necessary to execute the standard NVM unlocking sequence prior to executing the BOOTSWP instruction (writing 55h and AAh to the NVMKEY register in two sequential steps; see Section 4.1 “Registers” for more information). It is important to also disable interrupts before executing the unlock sequence. If the unlocking sequence is not performed, BOOTSWP will be executed as a forced NOP. The GOTO instruction following BOOTSWP is still executed, causing the PC to jump to that location in the current operating partition. Similarly, BOOTSWP has no effect in Standard Partition mode.
- The sequence at the bottom of Figure 3-3 shows the relationship between the partitions when a BOOTSWP instruction is executed. Note that a BOOTSWP partition change is temporary; after a subsequent device Reset, the partition with the lower Boot Sequence Number is reassigned to the Active Partition.

Figure 3-3: Comparing Partition Swap Methods





FLASH MEMORY PROGRAMMING

PIC24 and dsPIC33 devices can be programmed by any one of three methods:

- Run-Time Self-Programming (RTSP)
- In-Circuit Serial Programming™ (ICSP™)
- Enhanced In-Circuit Serial Programming (EICSP)

RTSP is performed by the application software during execution, while ICSP and EICSP are performed from an external programmer using a serial data connection to the device. ICSP and EICSP allow much faster programming time than RTSP. RTSP techniques are described in this section. The ICSP and EICSP protocols are defined in the programming specification documents for the respective devices, which can be downloaded from the Microchip website (www.microchip.com).

Registers

Programming operations are controlled through six registers. The NVMCON and NVMKEY registers are used to enable and select all operations. The remaining four registers define Data and Address Pointers.

Note: Not all devices implement data RAM buffer programming. Refer to the specific device data sheet for more information.

CONTROL REGISTERS

The NVMCON register (Register 4-1) controls all Flash programming operations. The NVMOP[3:0] bits (NVMCOM[3:0]) select the particular write or erase operation to be performed. The WR bit (NVMCOM[15]) triggers the appropriate operation; it remains set until the operation has been completed and is then cleared by hardware. The WREN bit (NVMCOM[14]) enables or disables write and erase operations. The WR bit cannot be set to trigger operations when WREN is clear.

The NVMKEY register (Register 4-2) is a write-only register used to prevent accidental writes of NVMCON that can corrupt Flash memory. Once unlocked, writes to NVMCON are allowed for one instruction cycle, in which the WR bit can be set to invoke an erase or program routine. Given the timing requirements, disabling interrupts is required.

To start an erase or programming sequence, the following steps are used:

1. Disable interrupts.
2. Write 0x55 to NVMKEY.
3. Write 0xAA to NVMKEY.
4. Start the programming write cycle by setting the WR bit (NVMCON[15]).
5. Execute two NOP instructions.
6. Restore interrupts.

Example 4-1 shows how the unlock sequence is performed.

Example 4-1: Disabling Interrupts with GIE Bit

```
; Disable interrupts
PUSH    INTCON2
BCLR    INTCON2, #GIE
NOP
; Load key values into NVMKEY
MOV     #0x55, W0
MOV     W0, NVMKEY
MOV     #0xAA, W0
MOV     W0, NVMKEY
; Set WR bit
BSET    NVMCON, #WR
NOP
NOP
; Restore interrupts
POP     INTCON2
```

Disabling Interrupts

Disabling interrupts is required for all Flash operations to ensure a successful result. If an interrupt occurs during the NVMKEY unlock sequence, it can block the write to the WR bit. The NVMKEY unlock sequence must be executed without interruption, as discussed in Section 3.2 “Dual Partition Modes”. Interrupts can be disabled in one of two methods, by disabling the Global Interrupt Enable (GIE bit), or by using the DISI instruction. The DISI instruction only disables interrupts of Priority 6 or below, therefore it is not recommended, and the Global Interrupt Enable method should be used.

CPU writes to GIE take two instruction cycles before affecting the code flow. Two NOP instructions are needed afterwards, or can be replaced with any other useful work instructions, such as loading NVMKEY; this is applicable to both set and clear operations. Care should be taken when re-enabling interrupts so that the NVM targeted routine does not allow interrupts when a previous called function has disabled them for other reasons. To address this in Assembly, a stack push and pop can be used to retain the state of the GIE bit. In C, a variable in RAM can be used to store INTCON2 prior to clearing GIE.

The following sequence should be used to disable interrupts:

1. Push INTCON2 onto the stack.
2. Clear the GIE bit.
3. Two NOPs or writes to NVMKEY.
4. Start the programming cycle by setting the WR bit (NVMCON[15]).
5. Restore GIE state by POP of INTCON2.

Example 4-1 provides the syntax in Assembly.

ADDRESS REGISTERS

The NVMADRL and NVMADRH registers define the Start Address Pointer for write operations. Both types of program memory writes (latch-based and RAM buffered) use these registers to set the destination address. The NVMSRCADRL and NVMSRCADRH registers define the starting address in data RAM of the source data when

using RAM buffered programming. The NVMSRCADRH register is used on devices with Extended Data Space (EDS) to point to addresses in the Extended Data Space memory.

Register 4-1: NVMCON: Flash Programming Control Register

R/S-0 ⁽¹⁾	R/C-0	R/C-0	R/W-0	R/C-0	R-0	R/W-0	R/C-0
WR	WREN	WRERR	NVMPIDL ⁽⁵⁾	SFTSWP	P2ACTIV	RPDF ⁽²⁾	URERR ⁽²⁾
bit 15	bit 8						

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	NVMOP[3:0]			
bit 7				bit 0			

Legend:	S = Settable Only bit	C = Clearable Only bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

- bit 15 **WR:** Write Control bit⁽¹⁾
1 = Initiates a Flash program/erase operation
0 = Program/erase operation is complete and inactive
- bit 14 **WREN:** Program/Erase Enable bit
1 = Allows program/erase cycles
0 = Inhibits programming/erasing of memory or fuse elements
- bit 13 **WRERR:** Sequence Error Flag bit
1 = An improper program/erase termination has occurred or an unimplemented programming operation has been selected
0 = A program or erase operation is under way, has completed normally or has yet to start
- bit 12 **NVMPIDL:** NVM Power-Down in Idle Enable bit⁽⁵⁾
1 = Removes power from Flash arrays when device enters Idle mode
0 = Keeps Flash arrays powered in Standby mode when device enters Idle mode
- bit 11 **SFTSWP:** Soft Swap Status bit
When BTMODE[1:0] = 10 or 0x:
1 = Partitions have been successfully swapped using the BOOTSWP instruction
0 = Awaiting successful partition swap using the BOOTSWP instruction
When BTMODE[1:0] = 11:
Unimplemented, read as '0'.
- bit 10 **P2ACTIV:** Dual Partition Active Status bit
When BTMODE[1:0] = 10 or 0x:
1 = Partition 2 Flash is the Active Partition
0 = Partition 1 Flash is the Active Partition
When BTMODE[1:0] = 11:
Unimplemented, read as '0'.
- bit 9 **RPDF:** RAM Buffer Row Programming Data Format Control bit⁽²⁾
1 = Row data are stored in RAM in compressed format
0 = Row data are stored in RAM in uncompressed format

Note

1. This bit is also reset on a Brown-out Reset (BOR).
2. RAM buffer row operations are not available on all devices; in those cases, these bits are unimplemented and read as '0'.
3. Selecting these options will set the WRERR bit and clear the WR bit.
4. Double-word program operations require two adjacent instruction words (24 bits each), aligned on a four-instruction word boundary.
5. Implemented in select devices only; refer to the specific device data sheet for details.

bit 8 **URERR:** RAM Buffer Row Programming Data Underrun Error Flag bit⁽²⁾
 1 = Programming operation has terminated due to a data underrun error
 0 = No data underrun error is detected.

bit 7-4 **Unimplemented:** Read as '0'

bit 3-0 **NVMOP[3:0]:** NVM Operation Select bits (initiated by the next setting of WR)
 1xxx = Reserved⁽³⁾
 011x = Reserved⁽³⁾
 0101 = Reserved⁽³⁾
 0100 = Inactive Partition erase operation (reserved option in Standard Partition mode)
 0011 = Page erase operation
 0010 = Row program operation
 0001 = Double-word program operation⁽⁴⁾
 0000 = Reserved⁽³⁾

Note

1. This bit is also reset on a Brown-out Reset (BOR).
2. RAM buffer row operations are not available on all devices; in those cases, these bits are unimplemented and read as '0'.
3. Selecting these options will set the WRERR bit and clear the WR bit.
4. Double-word program operations require two adjacent instruction words (24 bits each), aligned on a four-instruction word boundary.
5. Implemented in select devices only; refer to the specific device data sheet for details.

Register 4-2: NVMKEY: Nonvolatile Memory Key Register

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

W-0	W-0	W-0	W-0	W-0	W-0	W-0
W-0						
NVMKEY[7:0]						
bit 7	bit 0					

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

Table Operation Instructions

The table instructions provide one method of transferring data between the program memory space, and the data memory space of the PIC24 and dsPIC33 devices. A summary of the table instructions used during programming of the Flash program memory is provided in this section.

There are four basic table instructions:

- TBLRDL: Table Read Low
- TBLRDH: Table Read High
- TBLWTL: Table Write Low
- TBLWTH: Table Write High

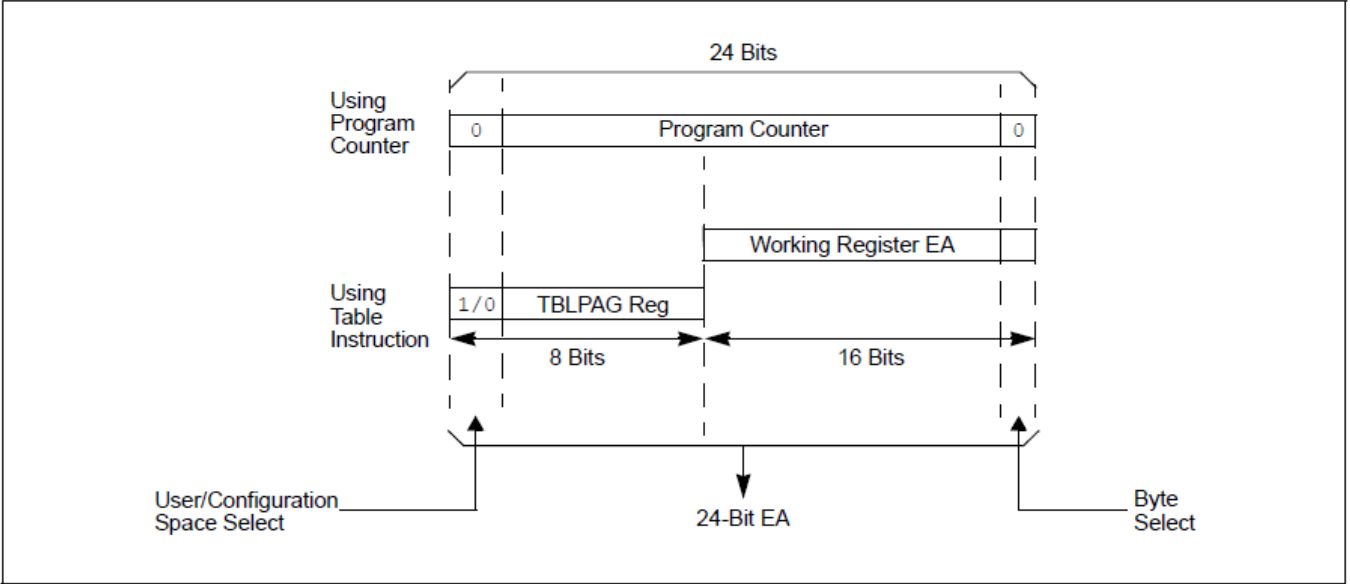
The TBLRDL and the TBLWTL instructions are used to read and write to bits[15:0] of program memory space. TBLRDL and TBLWTL can access program memory in Word or Byte mode. The TBLRDH and TBLWTH instructions are used to read or write to bits[23:16] of program memory space. TBLRDH and TBLWTH can access program memory in Word or Byte mode. Since the program memory is only 24 bits wide, the TBLRDH and TBLWTH instructions have the ability to address an upper byte of program memory that does not exist. This byte is called the 'phantom byte'. Any read of the phantom byte returns 00h; a write to the phantom byte has no effect.

ADDRESS GENERATION FOR TABLE OPERATIONS

The 24-bit program memory can be regarded as two, side-by-side 16-bit spaces, with each space sharing the same address range. Therefore, the TBLRDL and TBLWTL instructions access the 'low' program memory space (PM[15:0]). The TBLRDH and TBLWTH instructions access the 'high' program memory space (PM[31:16]). Any reads or writes to PM[31:24] will access the phantom (unimplemented) byte. When any of the table instructions are used in Byte mode, the LSb of the table address will be used as the byte select bit. The LSb determines which byte in the high or low program memory space is accessed.

Figure 4-1 illustrates how the program memory is addressed using the table instructions. A 24-bit program memory address is formed using the TBLPAG[7:0] bits and the Effective Address (EA) from a W register, specified in the table instruction (the 24-bit Program Counter is shown for reference). The upper 23 bits of the EA are used to select the program memory location. For the Byte mode table instructions, the LSb of the W register EA is used to pick which byte of the 16-bit program memory word is addressed. A '1' selects bits[15:8], a '0' selects bits[7:0]. The LSb of the W register EA is ignored for a table instruction in Word mode. In addition to the program memory address, the table instructions also specify a W register (or a W Pointer to a memory location) that is the source of the program memory data to be written or the destination for a program memory read. For a Table Write operation in Byte mode, bits[15:8] of the source Working register are ignored.

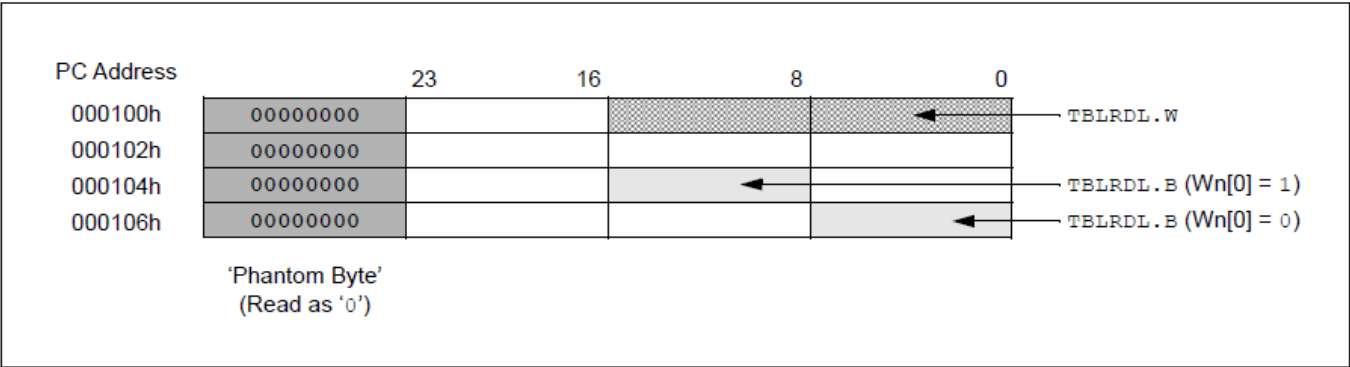
Figure 4-1: Addressing for Table Registers



LOW WORD ACCESS

The TBLRDL and TBLWTL instructions are used to access the lower 16 bits of program memory data. The LSb of the W register address is ignored for word-wide table accesses. For byte-wide accesses, the LSb of the W register address determines which byte is read. Figure 4-2 illustrates the program memory data regions accessed by the TBLRDL and TBLWTL instructions.

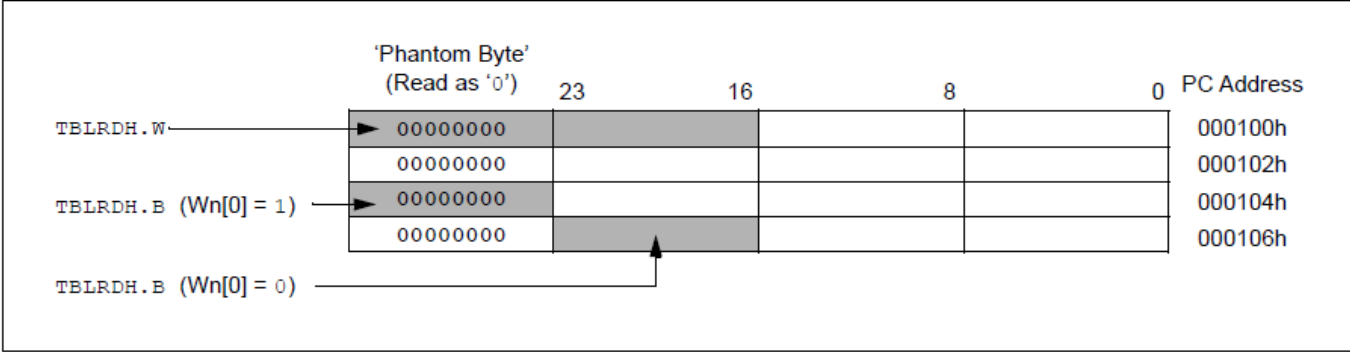
Figure 4-2: Program Data Table Access (Low Word)



HIGH WORD ACCESS

The TBLRDH and TBLWTH instructions are used to access the upper eight bits of the program memory data. These instructions also support Word or Byte Access modes for orthogonality, but the high byte of the program memory data will always return '0', as shown in Figure 4-3.

Figure 4-3: Program Data Table Access (High Word)



DATA STORAGE IN PROGRAM MEMORY

It is assumed that for most applications, the high byte (PM[23:16]) will not be used for data, making the program memory appear 16 bits wide for data storage. It is recommended that the upper byte of program data be programmed either as a NOP (00h or FFh), or as an illegal opcode (3Fh) value, to protect the device from accidental execution of stored data. The TBLRDH and TBLWTH instructions are primarily provided for array

program/verification purposes, and for those applications that require compressed data storage.

PROGRAM MEMORY BIT BEHAVIOR

Bits in Flash program memory can only be programmed from '1' to '0' and can be subsequently erased to '1'. Attempting to set a bit with a programming sequence will have no effect.

USING TABLE READ INSTRUCTIONS

Table Reads require two steps. First, an Address Pointer is set up using the TBLPAG register and one of the W registers. Then, the program memory contents at the address location may be read.

The code examples in Example 4-2 and Example 4-3 demonstrate how to read a word of program memory using the table instructions in Word mode.

Example 4-2: Read Word Mode (in Assembly)

```
; Set up the address pointer to program space
MOV    #tblpage(PROG_ADDR), W0      ; get table page value
MOV    W0, TBLPAG                   ; load TBLPAG register
MOV    #tbloffset(PROG_ADDR), W0    ; load address LS word
; Perform the table writes to load the latch
TBLRDL [W0], W2
TBLRDH [W0], W3
```

Example 4-3: Read Word Mode (in C)

```
int addrOffset;
int varWord1;
int varWord2;

TBLPAG = ((PROG_ADDR & 0x7F0000)>>16);
addrOffset = (PROG_ADDR & 0x00FFFE);

varWord1 = __builtin_tblrld(addrOffset);
varWord2 = __builtin_tblrhd(addrOffset);
```

Note: The `tblpage()` and `tbloffset()` directives are provided by the Microchip assembler for dsPIC33 and PIC24 devices. These directives select the appropriate TBLPAG and W register values for the table instruction from a program memory address value. Refer to the “MPLAB® Assembler, Linker and Utilities for PIC24 MCUs and dsPIC® DSCs User’s Guide” (DS51317) for more information.

TABLE WRITE HOLDING LATCHES

Table Write instructions do not write directly to the Flash program array. Instead, the instructions cause the data to be programmed to be loaded first into holding latches. These latches are memory-mapped in configuration memory space, typically starting at FA0000h, and can only be accessed using the Table Write instructions. When all of the holding latches have been loaded, the actual memory programming operation is started by executing a special sequence of instructions.

Different devices implement different numbers of holding latches, based on a specific program array design (i.e., the row programming size and row programming algorithm). Please refer to the specific device data sheet and/or programming specification for further details.

Performing a Two-Word Write

Word writes are performed for two words at a time using a pair of TBLWTH and TBLWTL instructions. The code sequences in either Example 4-4 or Example 4-5 (C equivalent) can be used to write two program memory latch locations to be programmed to Flash using Word Write mode.

Example 4-4: Two-Word Write Example (in Assembly)

```
; Set up the address pointer to 1st write latch
MOV    0xFA, W0                      ; get table page value
MOV    W0, TBLPAG                    ; load TBLPAG register
MOV    0x0, W0                      ; load address LS word
; Load write data into W registers
MOV    #PROG_LOW_WORD_1, W2
MOV    #PROG_HI_BYTE_1, W3
MOV    #PROG_LOW_WORD_2, W4
MOV    #PROG_HI_BYTE_2, W5
; Perform the table writes to load the latch
TBLWTL W2, [W0]
TBLWTH W3, [W0++]
TBLWTL W4, [W0]
TBLWTH W5, [W0++]
```

Example 4-5: Two-Word Write Example (in C)

```
int varWord1L = 0xFFFF;
int varWord1H = 0x00XX;
int varWord2L = 0xFFFF;
int varWord2H = 0x00XX;
int addrOffset;
int TargetWriteAddressL;           // bits[15:0]
int TargetWriteAddressH;           // bits[22:16]
int INTCON2Save;

NVMCON = 0x4001;                   // Set WREN and word program mode
TBLPAG = 0xFA;                     // write latch upper address
addrOffset = (PROG_ADDR & 0x00FFFE); // ensure address is properly aligned
NVMADRL = TargetWriteAddressL;     // set target write address
NVMADRH = TargetWriteAddressH;

__builtin_tblwtl(0, varWord1L);    // load write latches
__builtin_tblwth(0, varWord1H);
__builtin_tblwtl(0x2, varWord2L);
__builtin_tblwth(0x2, varWord2H);
INTCON2Save = INTCON2;
__builtin_disable_interrupts;      // Disable interrupts for NVM unlock sequence
__builtin_write_NVM();             // initiate write
INTCON2 = INTCON2Save;
```

Run-Time Self-Programming (RTSP)

RTSP allows the user code to modify Flash program memory contents. RTSP is accomplished using TBLRD (Table Read) and TBLWT (Table Write) instructions, and the NVM Control registers. PIC24 and dsPIC33 devices support the following Flash programming operations:

- Flash page erases
- Row programming (either latch-based or RAM-based)
- Word programming

Flash programming via RTSP is performed, either with blocks of memory called rows, or with two words of Flash memory. Prior to programming, a memory location must be erased. Erase operations are performed on blocks of memory, called pages, which consist of multiple rows. The size of a row will vary by device; refer to the device data sheet for details. Typically, for dsPIC33 and PIC24 devices, a page is defined as eight (8) rows. This document uses examples with 64 instructions per row (512 instructions per page).

ROW PROGRAMMING USING WRITE HOLDING LATCHES

As discussed in Section 4.2.7 “Table Write Holding Latches”, devices which implement latch-based row programming have holding latches which contain the programming data. Prior to the actual programming

operation, the write data must be loaded into the latches via TBLWT instructions in sequential order. When performing a row write, the instruction words must be loaded into the latches as a full row.

The basic sequence for RTSP programming is to set up a Table Pointer, then do a series of TBLWT instructions to load the buffers. Programming is performed by setting the control bits in the NVMCON register. For example, on a device with 64 instruction rows, a programming cycle would consist of 64 TBLWTL and 64 TBLWTH instructions to load the write latches, followed by a programming sequence unlocking NVMCON and setting the WR bit. Example 4-6 shows an example of the process.

Example 4-6: Row Programming with Write Latches (in C)

```
int varWordL[64];
int varWordH[64];
int targetWriteAddressL;           // bits[15:0]
int targetWriteAddressH;           // bits[22:16]
int i;
int INTCON2Save;

NVMCON = 0x4002;                   // Set WREN and row program mode
TBLPAG = 0xFA;
NVMADRL = targetWriteAddressH;     // set target write address
NVMADRH = targetWriteAddressL;

for(i=0; i<=63; i++)              // load write latches with data
{                                  // to be written
    __builtin_tblwtl(i, varWordL[i]);
    __builtin_tblwth((i * 2), varWordH[i]);
}
INTCON2Save = INTCON2;
__builtin_disable_interrupts;      // Disable interrupts for NVM unlock sequence
__builtin_write_NVM();             // initiate write
INTCON2 = INTCON2Save;
```

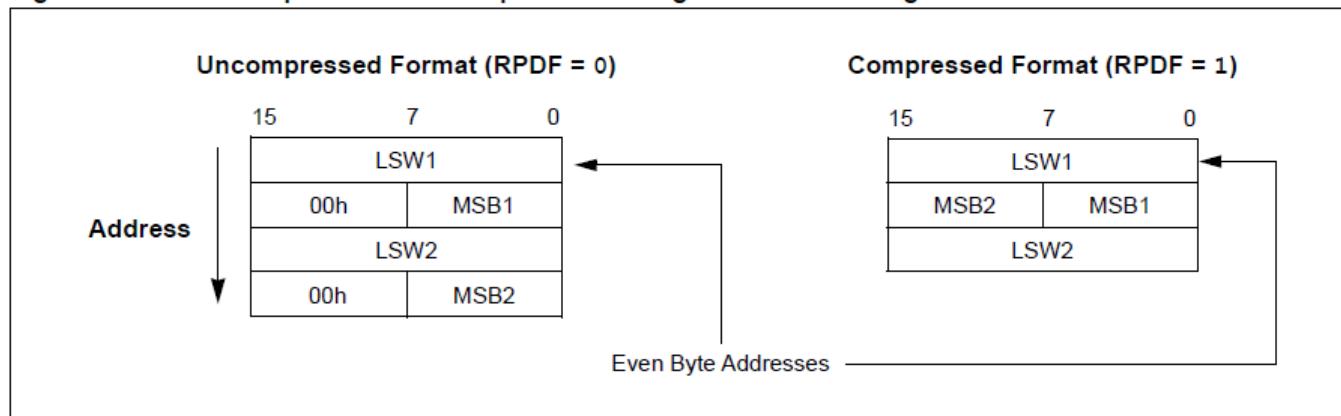
ROW PROGRAMMING USING THE RAM BUFFER

Select dsPIC33 and PIC24 devices permit row programming to be performed directly from a buffer space in data RAM, rather than going through the holding latches to transfer data with TBLWT instructions. The location of the RAM buffer is determined by the NVMSRCADR register(s), which are loaded with the data RAM address containing the first word of program data to be written.

Prior to performing the program operation, the buffer space in RAM must be loaded with the row of data to be programmed. The RAM can be loaded in either a compressed (packed) or uncompressed format. Compressed storage uses one data word to store the Most Significant Bytes (MSBs) of two adjacent program data words. The uncompressed format uses two data words for each program data word, with the upper byte of every other word being 00h. Compressed format uses about 3/4 of the space in data RAM as compared to uncompressed format. Uncompressed format, on the other hand, mimics the structure of the 24-bit program data word, complete with the upper phantom byte. The data format is selected by the RPDF bit (NVMCON[9]). These two formats are shown in Figure 4-4.

Once the RAM buffer is loaded, the Flash Address Pointers, NVMADRL and NVMADRH, are loaded with the 24-bit start address of the Flash row to be written. As with programming the write latches, the process is initiated by writing the NVM unlock sequence, followed by setting the WR bit. Once initiated, the device automatically loads the right latches and increments the NVM Address registers until all bytes have been programmed. Example 4-7 shows an example of the process. If NVMSRCADR is set to a value such that a data underrun error condition occurs, the URERR bit (NVMCON[8]) will be set to indicate the condition. Devices which implement RAM buffer row programming also implement one or two write latches. These are loaded using the TBLWT instructions and are used to perform word programming operations.

Figure 4-4: Uncompressed and Compressed Storage Formats for Program Data



Example 4-7: Writing Program Memory from a Data RAM Buffer (in C)

```
int data[64]; // Data to be programmed in RAM
int targetWriteAddressL; // bits[15:0]
int targetWriteAddressH; // bits[22:16]
int INTCON2Save;

NVMCON = 0x4002; // Row programming
NVMCONbits.RPDF = 0; // Select compressed format
NVMSRCADRL = (int)&data[0]; // Start address of data in RAM
NVMADRL = targetWriteAddressL;
NVMADRH = targetWriteAddressH;
INTCON2Save = INTCON2;

__builtin_disable_interrupts; // Disable interrupts for NVM unlock sequence
__builtin_write_NVM();
INTCON2 = INTCON2Save;
```

General Flash Programming Algorithms

Flash programming operations are controlled using the following Nonvolatile Memory (NVM) control registers:

- NVMCON
- NVMKEY
- NVMADRL/H
- NVMSRCADRL/H (some devices)

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. Setting the WR bit (NVMCON[15]) starts the operation and the WR bit is automatically cleared when the operation is finished.

When performing Flash programming operations on the Active Partition (particularly in Standard Partition mode), the CPU will stall until the operation is complete. When programming the Inactive Partition, the CPU can continue to operate without stalling. The following sections outline programming algorithms that exhibit CPU stall and no stall.

ERASING PROGRAM MEMORY (ACTIVE PARTITION)

1. Set the NVMOPx bits (NVMCOM[3:0]) to '0011' to configure for page erase and set the WREN bit (NVMCOM[14]).
2. Write the starting address of the block to be erased into the NVMADRL/H registers.
3. Disable interrupts.
4. Write 55h to NVMKEY.
5. Write AAh to NVMKEY.

6. Set the WR bit (NVMCOM[15]) to start the erase cycle.
7. Execute two NOP instructions.
8. Restore interrupts (optional).

When the erase is done, the WR bit is cleared automatically

ROW PROGRAMMING (ACTIVE PARTITION, STANDARD PARTITION MODE)

The user can program one row of program Flash memory at a time. To do this, it is necessary to erase the page containing the desired row. The general process for row programming to the Active Partition is:

1. Read eight rows of program memory (512 instructions) and store in data RAM.
2. Update the program data in RAM with the desired new data.
3. **Erase the block:**
 - **a)** Set the NVMOPx bits (NVMCOM[3:0]) to '0011' to configure for page erase and set the WREN bit (NVMCOM[14]).
 - **b)** Write the starting address of the block to be erased into the NVMADRL/H registers.
 - **c)** Disable interrupts.
 - **d)** Write 55h to NVMKEY.
 - **e)** Write AAh to NVMKEY.
 - **f)** Set the WR bit (NVMCOM[15]). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.
 - **g)** Restore interrupts (optional).
4. Write the first 64 instructions from data RAM into the program memory buffers (see Section 4.2.7 "Table Write Holding Latches") or write the NVMSRCADR register with the starting address of the data stored in RAM.
5. **Write the program block to Flash memory:**
 - **a)** Set the NVMOPx bits to '0010' to configure for row programming and set the WREN bit.
 - **b)** Disable interrupts.
 - **c)** Write 55h to NVMKEY.
 - **d)** Write AAh to NVMKEY.
 - **e)** Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.
 - **f)** Restore interrupts (optional).
6. Repeat Steps 4 and 5 using the next available 64 instructions from the block in data RAM, by incrementing the addresses in NVMADRL/H, until all 512 instructions are written back to Flash memory.

Note: Not all devices will exhibit CPU stall during a write or erase cycle. To avoid stalls, it is recommended to avoid reads or writes by the application to the row being erased or written.

For protection against accidental operations, the write initiate sequence for NVMKEY is required prior to any erase or program operation. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPs.

Note

1. The number of rows, blocks and holding latches may vary from device to device; please refer to the specific device data sheet for actual numbers, as well as the complete reference code of Flash memory programming.

2. For devices with a single holding latch, the Flash program memory must be written to by word programming.

PROGRAMMING A PAGE IN THE INACTIVE PARTITION (DUAL PARTITION MODES)

Programming in Dual Partition modes requires special considerations. Because the CPU is able to continue executing instructions while the Inactive Partition is being programmed, CPU stalls will not occur.

The algorithm for erasing and reprogramming a page of data in one of the Dual Partition modes is as follows:

1. Erase the block:

- **a)** Set the NVMOPx bits (NVMCOM[3:0]) to '0011' to configure for page erase.
- **b)** Set the WREN bit (NVMCOM[14]).
- **c)** Write the starting address of the block to be erased into the NVMADR registers with the page address.
- **d)** Disable interrupts.
- **e)** Write 55h to NVMKEY.
- **f)** Write AAh to NVMKEY.
- **g)** Set the WR bit (NVMCOM[15]). The erase cycle begins and the CPU will remain running.
- **h)** When the erase is done, the WR bit is cleared automatically and the NVM Write Complete Interrupt Flag (NVMIF) will occur.
- **i)** Restore interrupts (optional).

2. Prepare the data to be programmed by filling the RAM buffer; alternately, load the write latches with TBLWT instructions with the data for the first row of memory (64 instructions).

3. Program the block:

- **a)** Set the NVMOPx bits (NVMCON[3:0]) to '0010' to configure for row programming.
- **b)** Set the WREN (NVMCON[14]) bit.
- **c)** Write the starting address of the block to be written into the NVMADR registers with the row starting address.
- **d)** Disable interrupts.
- **e)** Write 55h to NVMKEY.
- **f)** Write AAh to NVMKEY.
- **g)** Set the WR bit (NVMCOM[15]). The write cycle begins and the CPU will remain running.
- **h)** When the erase is done, the WR bit is cleared automatically and the NVM Write Complete Interrupt Flag (NVMIF) will occur.
- **i)** Restore interrupts (optional).

4. Repeat Steps 2 and 3 to program each of the remaining rows of data in the erased page.

PROGRAMMING THE ENTIRE INACTIVE PARTITION (DUAL PARTITION MODES)

To entirely update the code in the Inactive Partition:

1. Erase the Inactive Partition:

- **a)** Set the NVMOPx bits (NVMCOM[3:0]) to '0100' to configure for Inactive Partition erase.
- **b)** Set the WREN bit (NVMCOM[14]).
- **c)** Disable interrupts.
- **d)** Write 55h to NVMKEY.
- **e)** Write AAh to NVMKEY.
- **f)** Set the WR bit (NVMCOM[15]). The erase cycle begins and the CPU will remain running during the

cycle.

- **g)** When the erase is done, the WR bit is cleared automatically, and the NVM Write Complete Interrupt Flag (NVMIF) occurs.
- **h)** Restore interrupts (optional).

2. Write each page of the Inactive Partition using page writes, as described in Section 4.4.3 “Programming a Page in the Inactive Partition (Dual Partition Modes)”.
3. Verify the written data. One suggested method is to perform a CRC on the data to be written and verify the CRC value on the full partition to ensure the data were written correctly.

UPDATING THE ACTIVE PARTITION USING A BOOTLOADER

1. Erase and program the entire Inactive Partition as described in Section 4.4.4 “Programming the Entire Inactive Partition (Dual Partition Modes)”.
2. Read the FBTSEQ Configuration register of the Active Partition.
3. Decrement the value by one and write to FBTSEQ of the Inactive Partition.
4. Force a partition swap:
 - **a)** If CPU stalls are not a concern, perform a device Reset. Since the Inactive Partition has a lower Boot Sequence Number, it will become the Active Partition after the Reset.
 - **b)** If a CPU stall is not acceptable, execute the BOOTSWP instruction.

PROGRAM SPACE VISIBILITY AND EXTENDED DATA SPACE (PSV AND EDS)

For all dsPIC33 and PIC24 devices, table instructions (see Section 4.2 “Table Operation Instructions”) can be used to access data within the program memory space. This is useful when data only need to be read or written, one byte or word at a time. It is also possible to map 16K word pages of the program memory space into the upper 32 Kbytes of the data address space. This allows an effective expansion of the data space beyond its normal 64-Kbyte addressing limits, as well as transparent access without the use of table instructions. All dsPIC33 and PIC24 devices are able to map any page in the implemented program memory space into the data space. This feature is known as Program Space Visibility (PSV). Some devices expand PSV by memory-mapping certain peripherals to a specific range of virtual program memory pages. This feature is particularly useful for peripherals, such as the Advanced Graphics Controller, which has high data throughput requirements. This expansion of PSV is known as Extended Data Space (EDS).

PSV and EDS are implemented as features of the data memory. They are implemented differently for dsPIC33 and PIC24 devices. For a detailed description, refer to the “dsPIC33/PIC24 Family Reference Manual”, “Data Memory”. (dsPIC33, DS70595) and/or “Data Memory” (PIC24, DS30009717).

PSV and Instruction Stalls

For more information about instruction stalls using PSV, refer to the “dsPIC33/PIC24 Family Reference Manual”, “dsPIC33E Enhanced CPU” (DS70005158).

REGISTER MAP

A summary of the SFRs associated with the Dual Partition Flash Program Memory is provided in Table 6-1.

Table 6-1: Special Function Registers Associated with Flash Program Memory(1)

File Name	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets (2)
TBLPAG	—	—	—	—	—	—	—	—	Table Page Address Pointer								0000
NVMCON	WR	WR EN	WR ER R	NV MPI DL	SF TS WP	P2 AC TIV	RP DF	UR ER R	—	—	—	—	NVMOP[3:0]			0000	
NVMKEY	—	—	—	—	—	—	—	—	NVMKEY[7:0]								0000
NVMSRCADRL	Data RAM Programming Buffer Start Address																0000
NVMSRCADRH	Data RAM Programming Buffer Address (EDS Operations Only)																0000
NVMA DRL	Flash Program Memory Destination Address, Lower Byte (ADDR[15:0])																0000
NVMA DRH	—	—	—	—	—	—	—	—	Flash Program Memory Destination Address, Upper Byte (ADDR[23:16])								0000

RELATED APPLICATION NOTES

This section lists application notes that are related to this section of the manual. These application notes may not be written specifically for the PIC24 or dsPIC33 product families, but the concepts are pertinent and could be used with modification and possible limitations. The current application notes related to the Dual Partition Flash Program Memory are:

Note: Please visit the Microchip website (www.microchip.com) for additional Application Notes and code examples for the PIC24 and dsPIC33 families of devices.

REVISION HISTORY

- **Revision A (March 2014)**

Original version of this document.

- **Revision B (February 2015)**

Changed the title and all instances of the phrase, “Dual Boot Flash Program Memory” to “Dual Partition Flash Program Memory” or “Dual Partition Flash”.

- **Revision C (November 2021)**

Added 4.1.1.1 “Disabling Interrupts”.

Updated 4.1.1 “Control Registers”, 4.4.2 “Row Programming (Active Partition, Standard Partition Mode)”, 4.4.3 “Programming a Page in the Inactive Partition (Dual Partition Modes)” and 4.4.4 “Programming the Entire Inactive Partition (Dual Partition Modes)”. Updated Example 4-5, Example 4-6 and Example 4-7.

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Documents / Resources

	<p>MICROCHIP PIC24 Dual Partition Flash Program Memory [pdf] User Guide</p> <p>PIC24 Dual Partition Flash Program Memory, PIC24, Dual Partition Flash Program Memory, Flash Program Memory, Program Memory</p>
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